





40V PNP LOW SATURATION TRANSISTOR AND 40V, 1A SCHOTTKY DIODE COMBINATION

Features and Benefits

PNP Transistor

- BV_{CEO} > -40V
- I_C = -3A Continuous Collector Current
- Low Saturation Voltage (-220mV max @ -1A)
- $R_{SAT} = 104m\Omega$ for a low equivalent On-Resistance
- h_{FE} characterized up to -3A for high current gain hold up

Schottky Diode

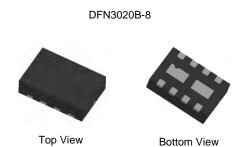
- BV_R > 40V
- I_{FAV} = 3A Average Peak Forward Current
- Low V_F < 500mV (@1A) for reduced power loss
- Fast switching due to Schottky barrier
- Low profile 0.8mm high package for thin applications
- R_{θJA} efficient, 40% lower than SOT26
- 6mm² footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

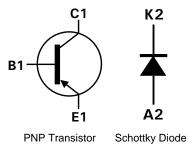
Mechanical Data

- Case: DFN3020B-8
- Case Material: Molded Plastic, "Green" Molding Component
- Terminals: Pre-Plated NiPdAu leadframe
- Nominal package height: 0.8mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.013 grams (approximate)

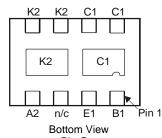
Applications

- DC DC Converters
- Charging circuits
- Mobile phones
- Motor control
- Portable applications





Equivalent Circuit



Pin-Out n/c = Not Connected internally

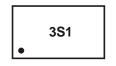
Ordering Information (Note 3)

Ī	Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
	ZXTPS720MCTA	3S1	7	8	3000

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" Policy can be found on our website http://www.diodes.com
- 3. For packaging details, go to our website http://www.diodes.com

Marking Information



3S1 = Product type marking code Top view, dot denotes pin 1





PNP - Maximum Ratings @ TA = 25°C unless otherwise specified

Parameter		Symbol	Limit	Unit	
Collector-Base Voltage Collector-Emitter Voltage		or-Base Voltage V _{CBO}			
		Voltage V _{CEO}			
Emitter-Base Voltage		V _{EBO}	-7	7	
Peak Pulse Current		I _{CM}	-4		
Continuous Collector Current	(Notes 4 and 7)	I-	-3	۸	
Continuous Collector Current	(Notes 5 and 7)	IC	-3.4		
Base Current		Ι _Β	-1		

PNP - Thermal Characteristics @ TA = 25°C unless otherwise specified

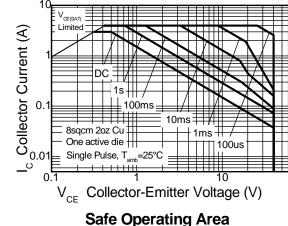
Characteristic		Symbol	Value	Unit	
	(Notes 4 & 7)		1.5 12		
Power Dissipation	(Notes 5 & 7)	P_D	2.45 19.6	W mW/°C	
Linear Derating Factor	(Notes 6 & 7)		1.13 8		
	(Notes 6 & 8)		1.7 13.6		
	(Notes 4 & 7)		83.3		
Thermal Desistance Investigate Archivet	(Notes 5 & 7)	_	51.0		
Thermal Resistance, Junction to Ambient	(Notes 6 & 7)	$R_{\theta JA}$	111	°C/W	
	(Notes 6 & 8)		73.5		
Thermal Resistance, Junction to Lead	(Note 9)	$R_{ heta JL}$	17.1		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

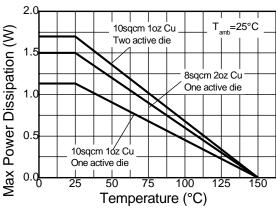
Notes:

- 4. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector and cathode pads connected to each half.
- 5. Same as note (4), except the device is measured at t <5 sec.
- 6. Same as note (4), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.
- 7. For a dual device with one active die.
- 8. For dual device with 2 active die running at equal power.
- 9. Thermal resistance from junction to solder-point (on the exposed collector pad).

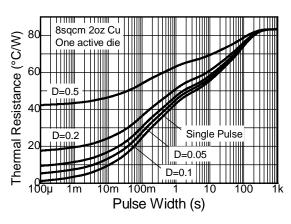


PNP - Thermal Characteristics

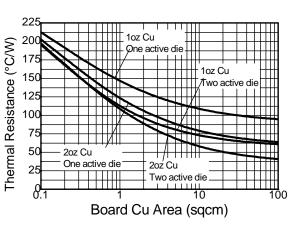




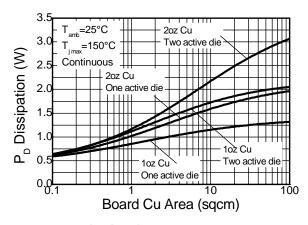
Derating Curve



Transient Thermal Impedance



Thermal Resistance v Board Area



Power Dissipation v Board Area





Schottky - Maximum Ratings @ TA = 25°C unless otherwise specified

Parameter	Symbol	Limit	Unit	
Continuous Reverse Voltage		V_{R}	40	V
Continuous Forward Current		I _F	1.85	
Repetitive Peak Forward Current	D = 0.5 Pulse width ≤ 300µs	I _{FRM}	3	А
Non-Repetitive Peak Forward Surge Current	t ≤ 100µs t ≤ 10ms	I _{FSM}	12 7	

Schottky - Thermal Characteristics @ TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
	(Notes 10 & 13)		1.2 12		
Power Dissipation	(Notes 11 & 13)		2 20	W	
Linear Derating Factor	(Notes 12 & 13)	P_D	0.9 9	mW/°C	
	(Notes 12 & 14)		1.36 13.6		
	(Notes 10 & 13)		83.3		
Thermal Desistance, Junction to Ambient	(Notes 11 & 13)	5	51.0		
Thermal Resistance, Junction to Ambient	(Notes 12 & 13)	$R_{\theta JA}$	111	°C/W	
	(Notes 12 & 14)		73.5	1	
Thermal Resistance, Junction to Lead	(Note 15)	$R_{ heta JL}$	20.2		
Storage Temperature Range		T _{STG}	-55 to +150	°C	
Maximum Junction Temperature		T_J	125	°C	

Notes:

- 10. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed cathode and collector pads connected to each half.

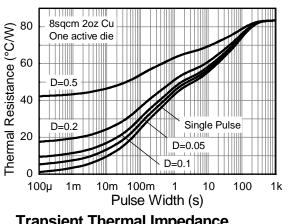
 11. Same as note (10), except the device is measured at t <5 sec.

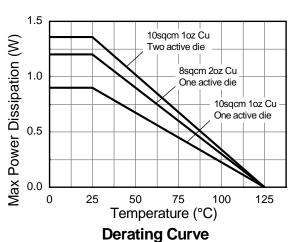
 12. Same as note (10), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.

- 13. For a dual device with one active die.
- 14. For dual device with 2 active die running at equal power.
- 15. Thermal resistance from junction to solder-point (on the exposed cathode pad).

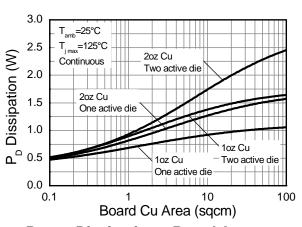


Schottky - Thermal Characteristics

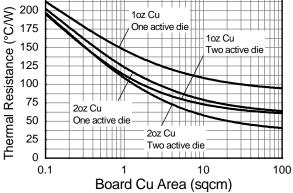




Transient Thermal Impedance



225 1oz Cu One active die 1oz Cu



Power Dissipation v Board Area

Thermal Resistance v Board Area





PNP - Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-50	-80	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 16)	BV _{CEO}	-40	-70	-	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.5	-	V	$I_E = -100 \mu A$
Collector Cutoff Current	I _{CBO}	-	-	-100	nA	V _{CB} = -40V
Emitter Cutoff Current	I _{EBO}	-	-	-100	nA	$V_{EB} = -6V$
Collector Emitter Cutoff Current	I _{CES}	-	-	-100	nA	V _{CES} = -32V
		300	480	-		$I_C = -10 \text{mA}, V_{CE} = -2 \text{V}$
		300	450	-		I _C = -100mA, V _{CE} = -2V
Static Forward Current Transfer Ratio (Note 16)	h _{FE}	180	290	-	-	$I_C = -1A$, $V_{CE} = -2V$
		60	130	-		I _C = -1.5A, V _{CE} = -2V
		12	22	-		$I_C = -3A$, $V_{CE} = -2V$
		-	-25	-40	mV	$I_C = -0.1A$, $I_B = -10mA$
		-	-150	-220		$I_C = -1A$, $I_B = -50mA$
Collector-Emitter Saturation Voltage (Note 16)	$V_{CE(sat)}$	-	-195	-300		$I_C = -1.5A$, $I_B = -100mA$
		-	-210	-300		$I_C = -2A$, $I_B = -200mA$
		-	-260	-370		$I_C = -2.5A$, $I_B = -250mA$
Base-Emitter Turn-On Voltage (Note 16)	V _{BE(on)}	-	-0.89	-0.95	V	$I_C = -2.5A$, $V_{CE} = -2V$
Base-Emitter Saturation Voltage (Note 16)	V _{BE(sat)}	-	-0.97	-1.05	V	$I_C = -2.5A$, $I_B = -250mA$
Output Capacitance	C _{obo}	-	19	25	pF	V _{CB} = -10V, f = 1MHz
Transition Frequency	f _T	150	190	-	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz
Turn-on Time	t _{on}	-	40	-	ns	$V_{CC} = -15V, I_{C} = -0.75A$
Turn-off Time	t _{off}	-	435	-	ns	$I_{B1} = I_{B2} = -15\text{mA}$

Schottky - Electrical Characteristics @TA = 25°C unless otherwise specified

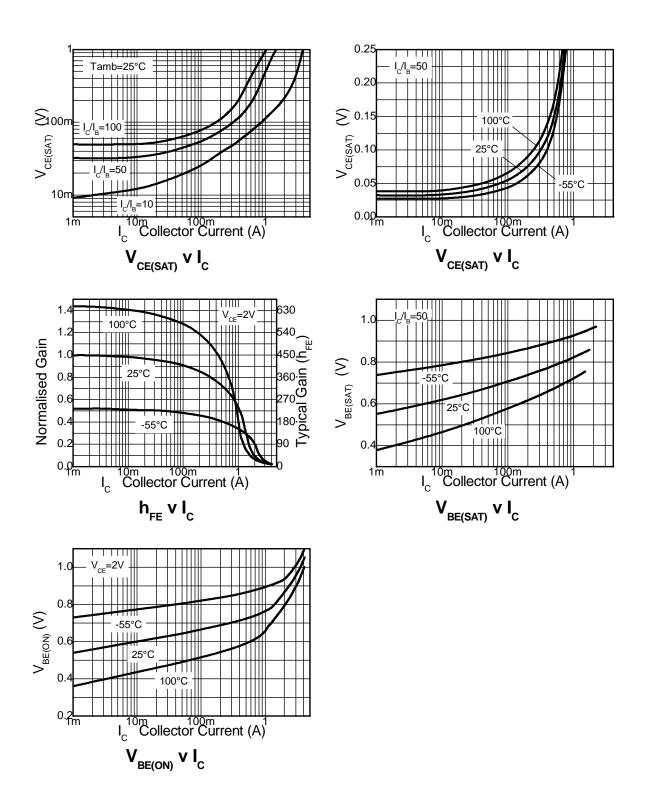
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	BV_R	40	60	-	V	$I_R = -300 \mu A$
		-	240	270	mV	$I_F = 50 \text{mA}$
	V _F	-	265	290		$I_F = 100 \text{mA}$
		-	305	340		$I_F = 250 \text{mA}$
Farward Valtage (Note 16)		-	355	400		$I_F = 500 \text{mA}$
Forward Voltage (Note 16)		-	390	450		I _F = 750mA
		-	425	500		$I_F = 1000 \text{mA}$
		-	495	600		$I_F = 1500 \text{mA}$
		-	420	-		$I_F = 1000 \text{mA}, T_A = 100 ^{\circ}\text{C}$
Reverse Current	I _R	-	50	100	μΑ	$V_R = 30V$
Diode Capacitance	C_D	-	25	-	pF	$V_R = 25V, f = 1MHz$
	t _{rr}					switched from
Reverse Recovery Time		-	12	-	ns	$I_F = 500 \text{mA}$ to $I_R = 500 \text{mA}$
						Measured at I _R = 50mA

Notes: 16. Measured under pulsed conditions. Pulse width $\leq 300 \mu s$. Duty cycle $\leq 2\%$.



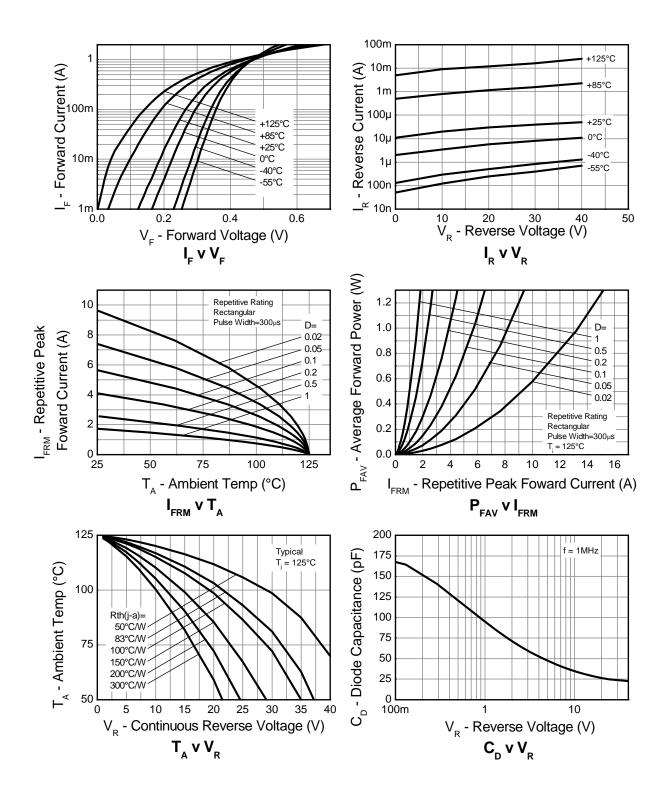


PNP - Typical Electrical Characteristics





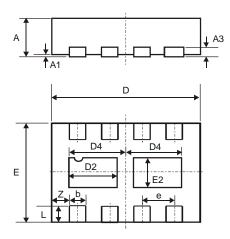
Schottky - Typical Electrical Characteristics





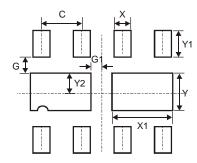


Package Outline Dimensions



DFN3020B-8					
Dim	Min	Max	Тур		
Α	0.77	0.83	0.80		
A1	0	0.05	0.02		
A3	-	-	0.15		
b	0.25	0.35	0.30		
D	2.95	3.075	3.00		
D2	0.82	1.02	0.92		
D4	1.01	1.21	1.11		
е	-	-	0.65		
Е	1.95	2.075	2.00		
E2	0.43	0.63	0.53		
L	0.25	0.35	0.30		
Z	-	-	0.375		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
X	0.400
X1	1.120
Y	0.730
Y1	0.500
Y2	0.365





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